AC-LGAD sensor measurements and Simulation

Carlos Munoz Camacho, Dominique Marchand, Laurent Serin, Wang Pu-Kai

16/09/2021

Outlook

- Testboard measurements B19, 30
 - sharing
 - TDC performances
- Pixel detector simulation model study
 - to know the spatial resolution under different ADC-bit

Experimental setup

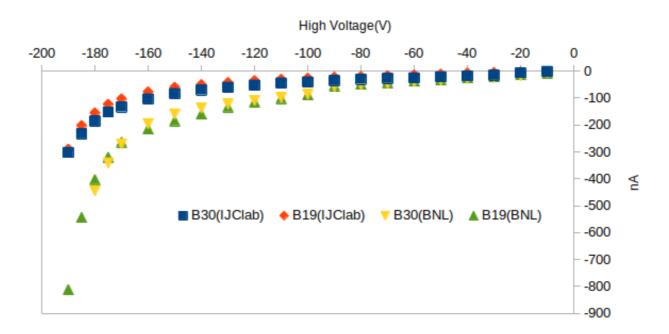




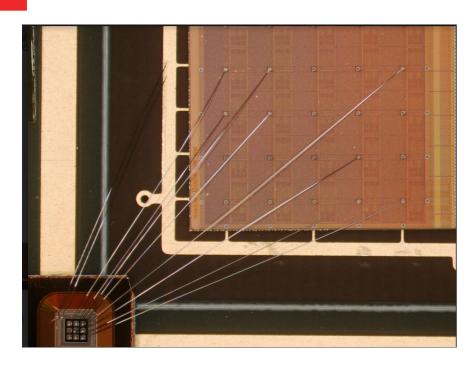
Sensor and the ASIC are in the dark box

IV curve of B19 and 30

- The I-V curve comparison between IJClab and BNL
- The difference between IJClab and BNL comes from the experimental setup.



Channel sharing of B19



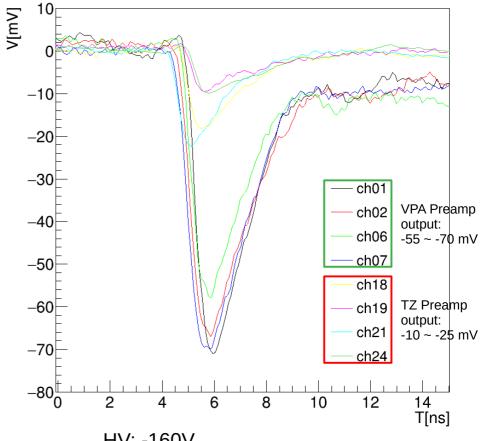
Preamp:VPA

0	5	10	15	20
1	6	11	16	21
2	7	12	17	22
3	8	13	18	23
4	9	14	19	24

1	2	7
ИС	6	18
21	19	24

Preamp:TZ

Probe the injected channel turn off the other 24 channels



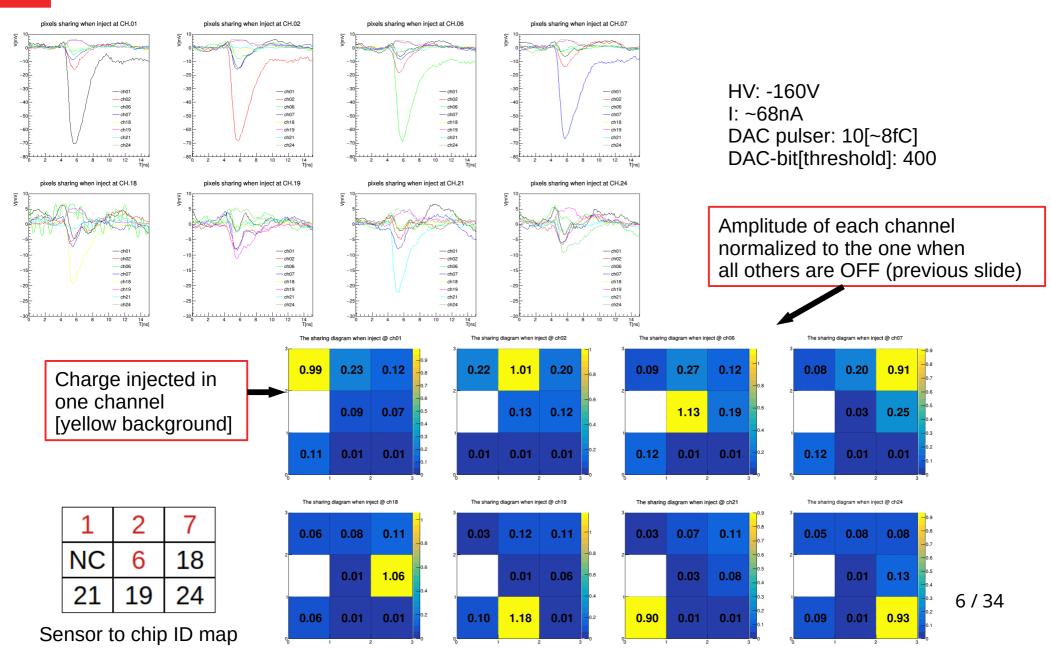
HV: -160V I: ~68nA

DAC pulser: 10[~8fC]

DAC-bit[threshold]: 400

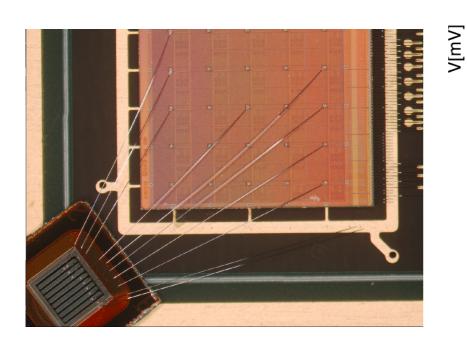
5/34

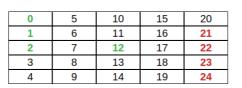
Channel sharing of B19



Channel sharing of B30

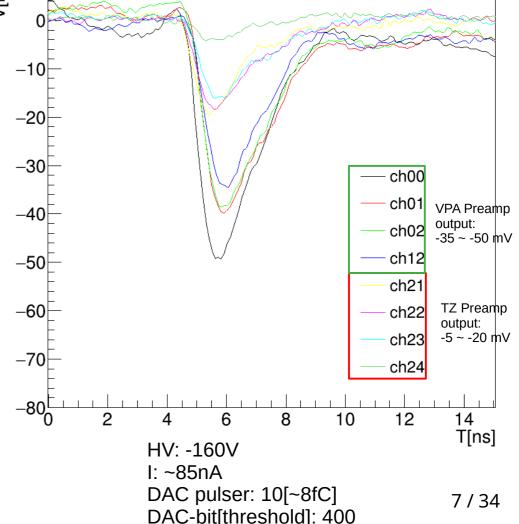
Probe the injected channel turn off the other 24 channels





Preamp: VPA

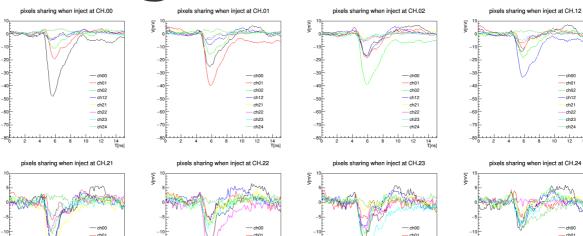
0 1 2 12 21 22 23 24 Preamp: TZ



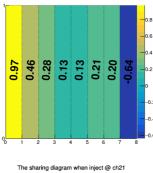
Pixel sharing of B30

HV: -160V I: ~68nA

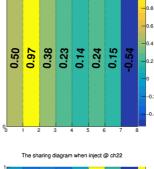
DAC pulser: 10[~8fC] DAC-bit[threshold]: 400



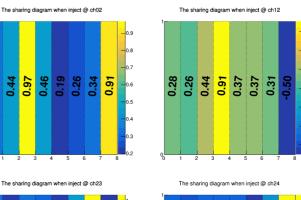
The high ratio at ch24 in the ch2 sharing would be caused from forgot to switch the probe.

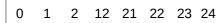


The sharing diagram when inject @ ch00

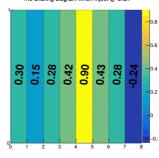


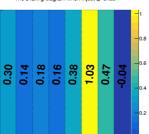
The sharing diagram when inject @ ch01

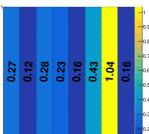


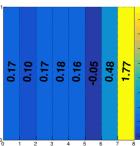


Sensor to chip ID map



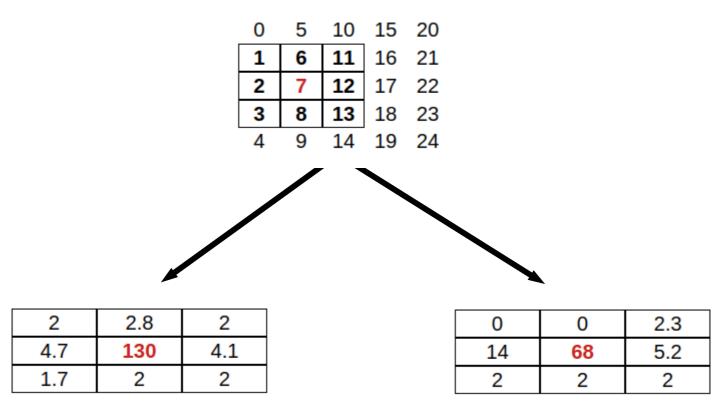






Sharing between connected and nonconnected sensor

- Except for sensor connection, B12 is same as B19
- Inject charge ~8fC into ch.07, then probing others.

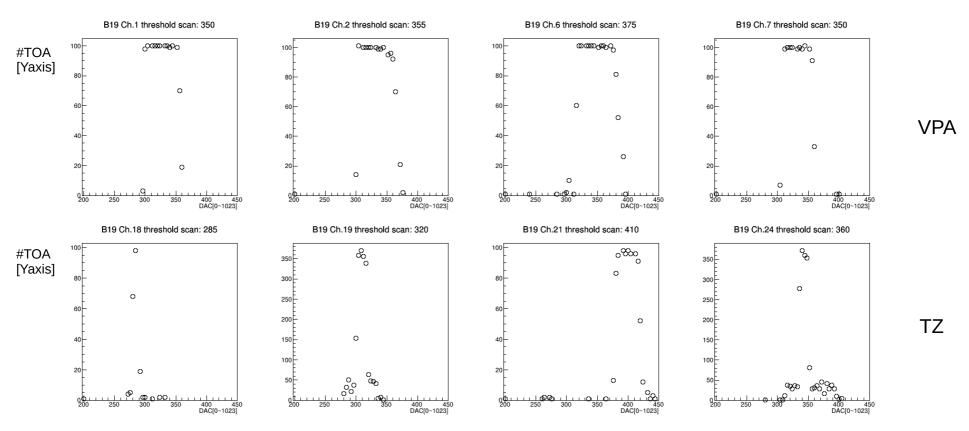


- 2 TDC => TOA & TOT
- Discriminator: const. threshold value type.
- To know the time-walk effect, jitter and determine the TOA LSB.
 - Threshold scan
 - Determine TOA LSB by Delay scan
 - Charge scan => time walk and jitter in different charge.

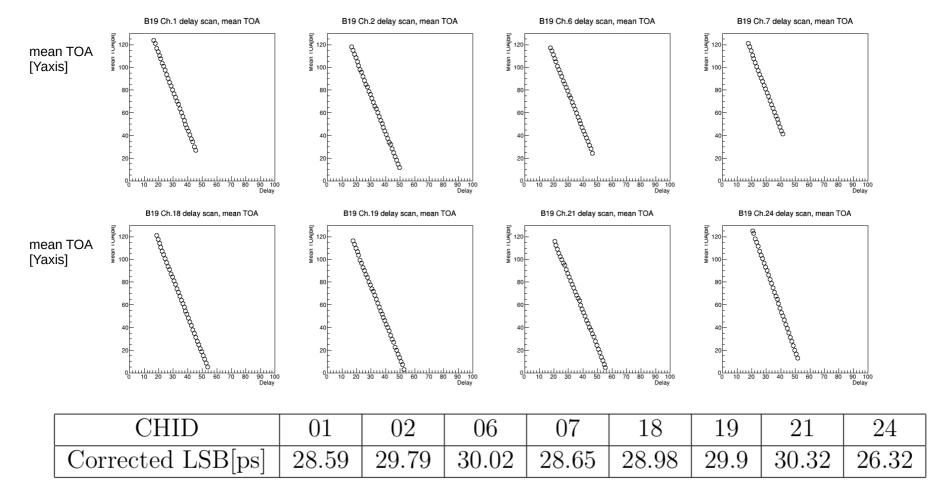
Threshold scan

Q = 3 (2.5fC) for 8 channels

Know the proper threshold value for each channels

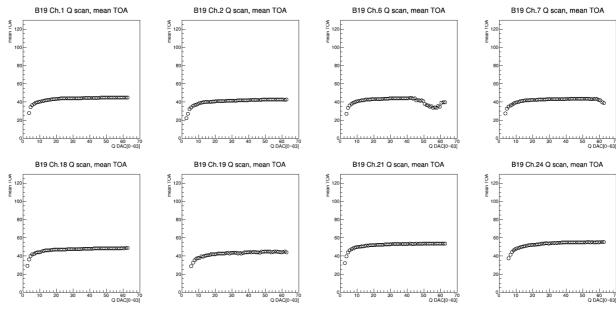


- Delay scan
 - Q = 30[25fC] for all channels
- each delay bit[10ps], using slope and delay bit to determine TOA LSB

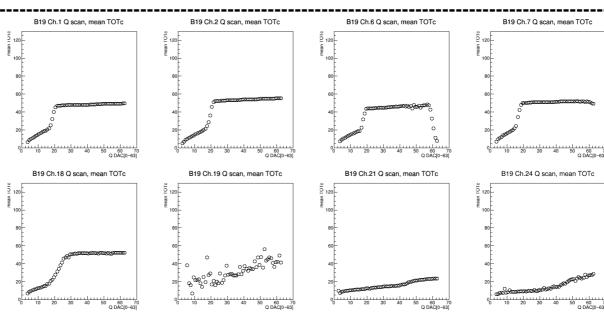




Mean TOA[bit] v.s. Q time walk effect



Mean TOT[bit] v.s. Q The saturation start $\sim Q = 25bit(21fC)$

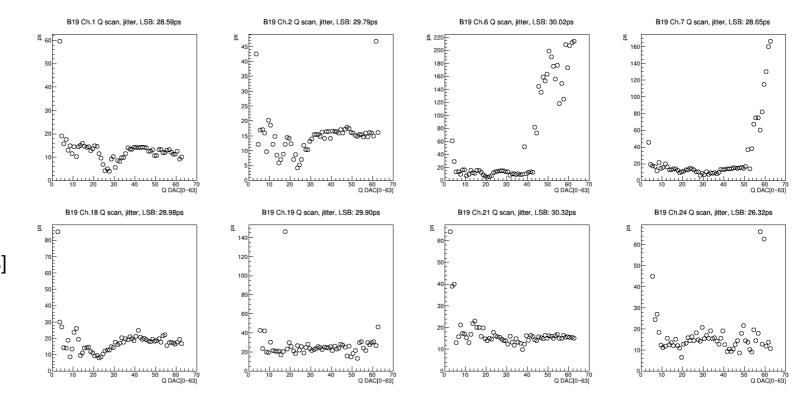


13/34

Charge scan

jitter[ps] v.s. Q

jitter: 15~20 ps Calculated from determined LSB[~30ps]

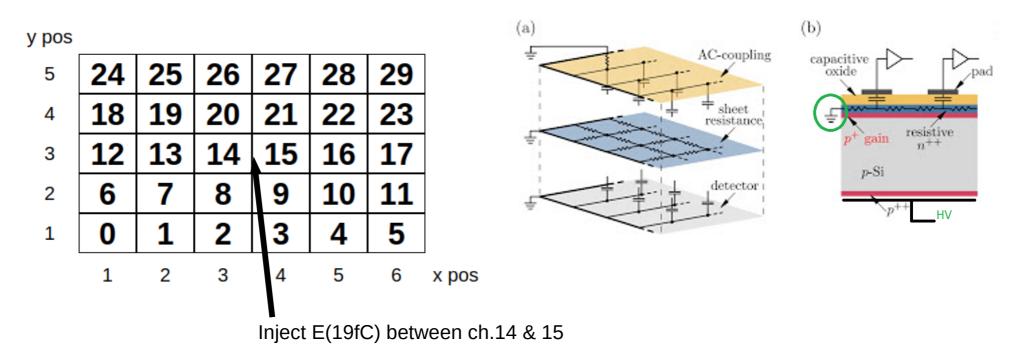


conclusion

- The determined LSB value for each TDC is ~30ps.
- Most channel have saturated issue, as Q>21, shown in the charge scan
- The average jitter for each channel is 15~20ps. All these 8 TDC performance are uniform
- Measure the signal by TOA & TOT
- B30 has problem on TOA measurements, still investigated.
- Beta source and infrared laser measurement will conducted in future.

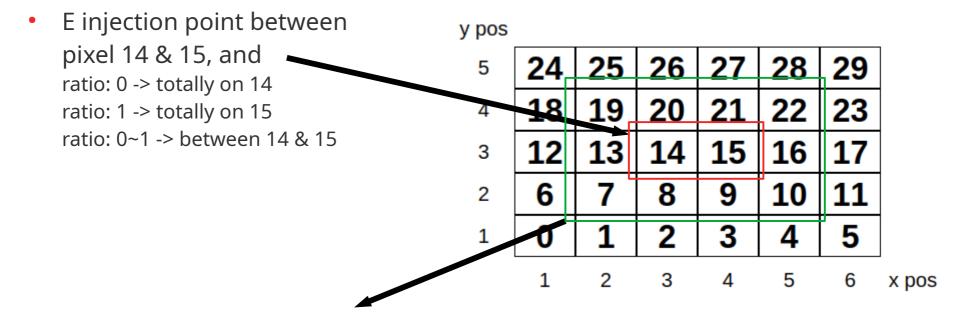
Simulation of pixel sensor

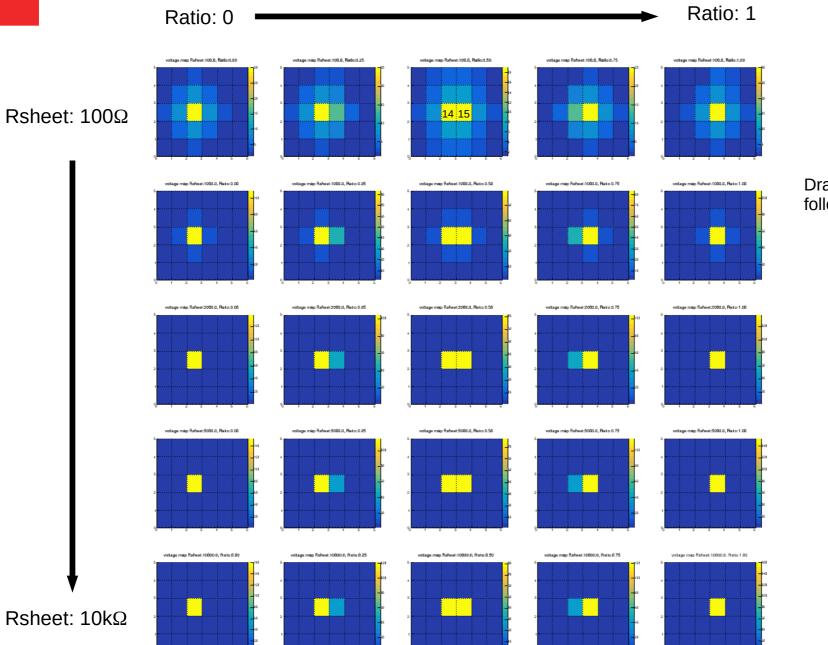
- Maxime build a electronics model about 5x6 pixel sensor
- Simulate the preamp(TZ) output with different inject points
- To know the spatial resolution difference between ADC 8 & 10 bit



Simulation of pixel sensor

- 30 pixels in single pad
- Extract the data(voltage) from excel(Maxime) and draw them in 2D plot
- Each pixel connect each other with resistor Rsheet: 100Ω , $1k\Omega$, $2k\Omega$, $5k\Omega$, $10k\Omega$



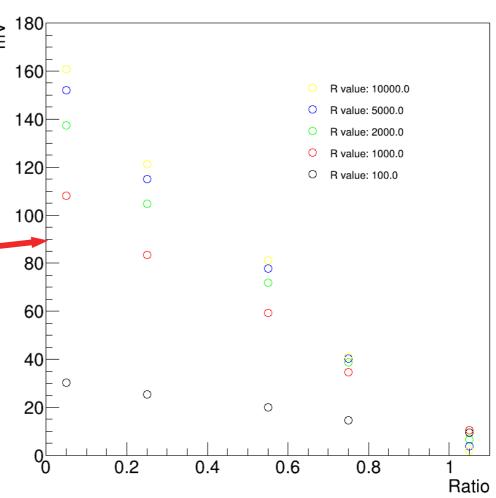


Draw Maxime simulation data followed above map

Linearity vs ratio

Pixel 14 voltage vary with ratio

- We can estimate the amplitude at any given ratio between 0~1
- The significant Amp difference between different R value.

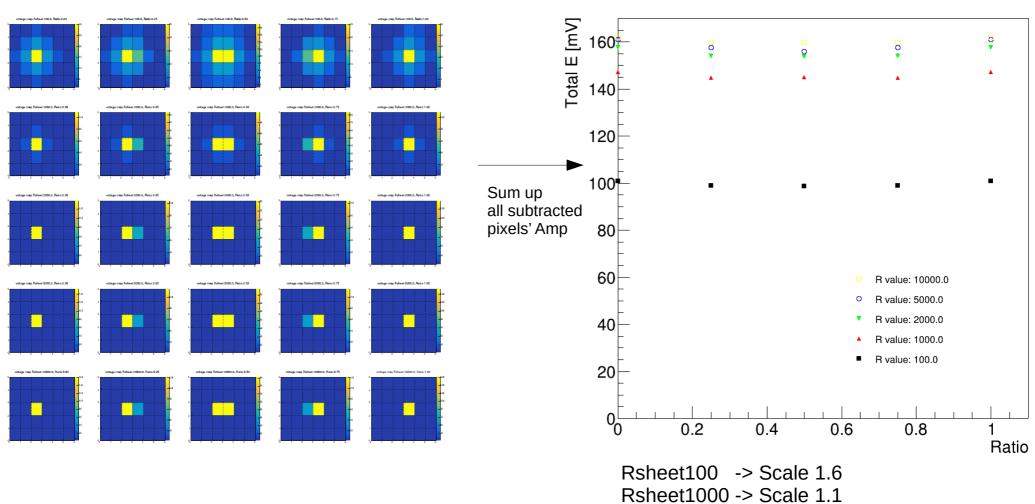


From Maxime simulation data without subtraction and scaling

Total E

Total Energy of single pad

20 / 34



- Reconstruct inject position: $\Sigma(Pos_i * V_i) / \Sigma V_i$
- 3 differet cases for Maxime data:
 - Reconstruct with all pixels without subtraction
 - Reconstruct with all pixels with subtraction
 - Reconstruct with 3x4 pixels with subtraction

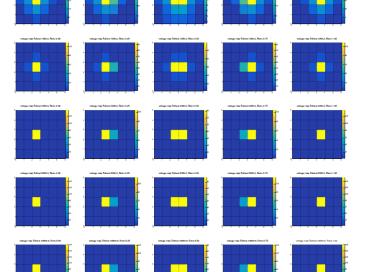


0.25 | 0.5 | 0.75 | 1

0.116	0.301	0.503	0.707	0.888
0.103	0.3	0.5	0.7	0.897
0.0962	0.285	0.5	0.715	0.904
0.0941	0.289	0.5	0.711	0.906
0.0934	0.296	0.5	0.704	0.907

-0.0271	0.226	0.504	0.785	1.03
0.00177	0.249	0.5	0.751	0.998
0.000273	0.233	0.5	0.767	1
0.000267	0.239	0.5	0.761	1
0.000556	0.249	0.5	0.751	1

0.0842	0.292	0.502	0.711	0.919
-0.000246	0.247	0.5	0.753	1
-0.000311	0.232	0.5	0.768	1
-0.000329	0.239	0.5	0.761	1
-0.000339	0.249	0.5	0.751	1



10000

100

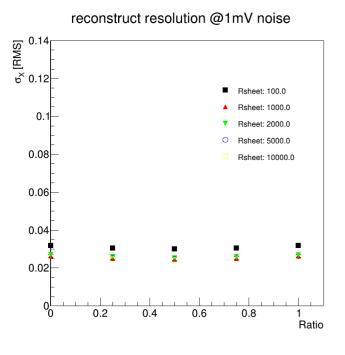
100

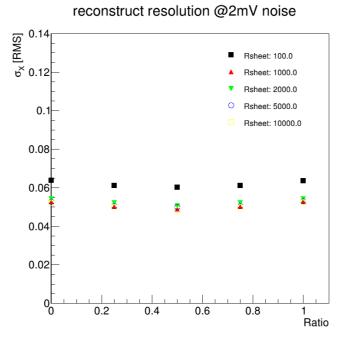
10000

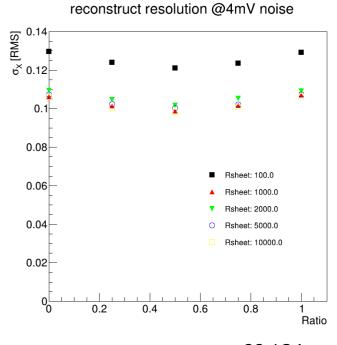
100

10000

- Add noise to each pixel independently.
- noise_i: Gaus(mean: 0mv, width: 1, 2, 4mv) $\Sigma(\text{Pos}_i * (V_i + \text{noise}_i)) / \Sigma(V_i + \text{noise}_i) , \quad V_i : \text{Maxime data after the zero subtraction}$ When Rsheet=100 Ω & 1000 Ω , $\Sigma(\text{Pos}_i * (\text{scale} * V_i + \text{noise}_i)) / \Sigma(\text{scale} * V_i + \text{noise}_i)$, scale 1.6 & 1.1
- The reconstruction only consider 3x4 region



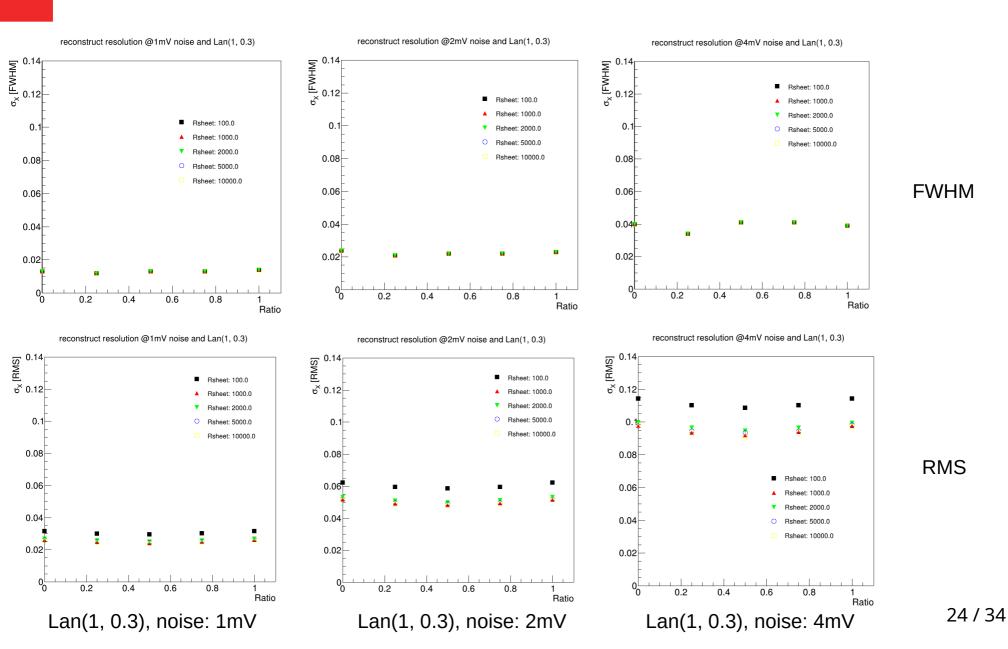




22 / 34

- Smear the injection energy with Landau
- Multiply each pixel voltage with value from Landau distribution Lan = Landau(1., 0.3), noise, = Gaus(0, 1mV) $\Sigma(\text{Pos}_i * (V_i * \text{Lan} + \text{noise}_i)) / \Sigma(V_i * \text{Lan} + \text{noise}_i), \quad V_i : \text{Maxime data after the zero subtraction} \\ \text{When Rsheet} = 100\Omega \& 1000\Omega, \\ \Sigma(\text{Pos}_i * (\text{scale} * V_i * \text{Lan} + \text{noise}_i)) / \Sigma(\text{scale} * V_i * \text{Lan} + \text{noise}_i), \\ \text{scale } 1.6 \& 1.1$
- The reconstruction only consider 3x4 region
- The position resolution will calculated by FWHM and RMS.

Y-axis in same scale



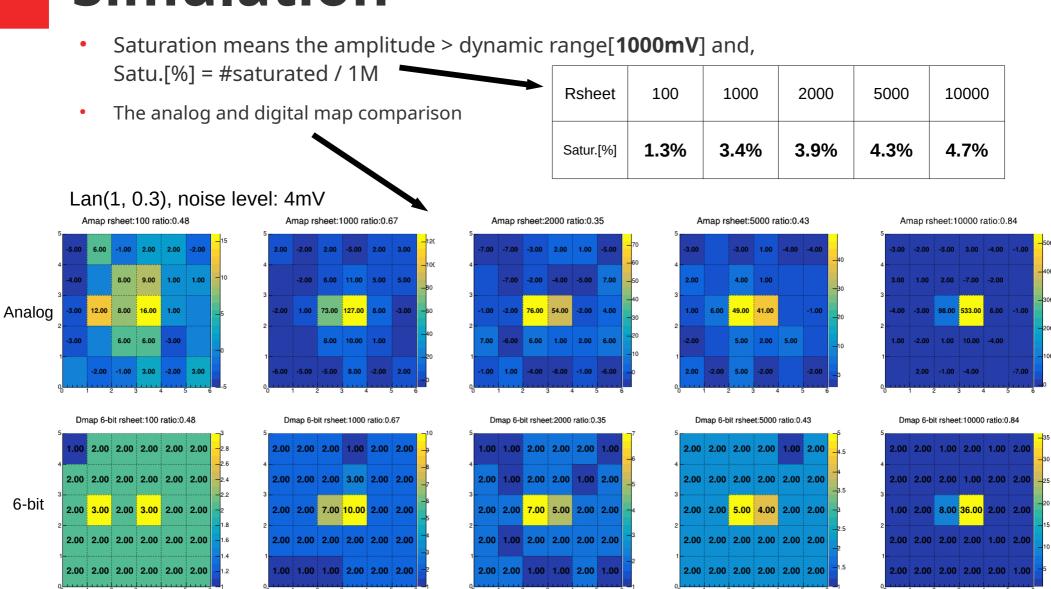
ADC

- Randomly choose the inject ratio from Uniform(0, 1): R_U (ratio uniform), pixel 14 15
- Dynamic range: 1000mV
- Noise scale: 1 and 4 mV, Smear with Lan(1, 0.3)
- LSB: Dynamic range / 2^{n-bit}
- ADC bit: 4, 6, 8, 10, 12
- The reconstruction only consider 3x4 region
- Calculate the amplitude of pixel;:

$$\begin{aligned} &\text{Amp}_{\text{i, analog}} = [\text{V}_{\text{i,0}} + (\text{V}_{\text{i,1}} - \text{V}_{\text{i,0}}) \times \text{R}_{\text{U}}] \times \text{Lan}(1, 0.3) + \text{Gaus}_{\text{i}}(0, 1), \text{ Rsheet100, 1000 need to be scaled} \\ &\text{Amp}_{\text{i, digital}} = \text{Ceil}[(\text{Amp}_{\text{i, analog}} + 5 \times 1\text{mV}) / \text{LSB}] \text{ (non saturated case)} \\ &\text{Amp}_{\text{i, digital}} = \text{Ceil}[1000 / \text{LSB}] \text{ (saturated case)} \end{aligned}$$

Reconstruct the position:

$$\Sigma(Pos_i \times Amp_{i, digital}) / \Sigma(Amp_{i, digital})$$

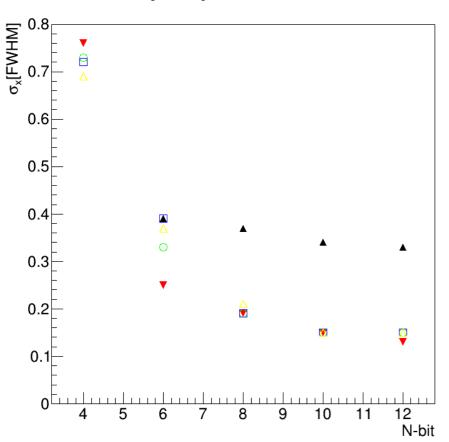


1 LSB for 6-bit = 15.625mV And there is 5-sigma shift(5*4mV = 20mV) for the pedestal the digital noise would around 2bits.

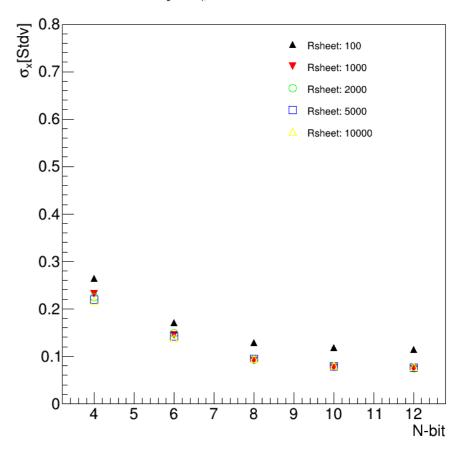
Simulation ADC

Smear with Lan(1, 0.3) Noise: 1mV

Pos Reso[FWHM] @ N-bit and different Rsheet



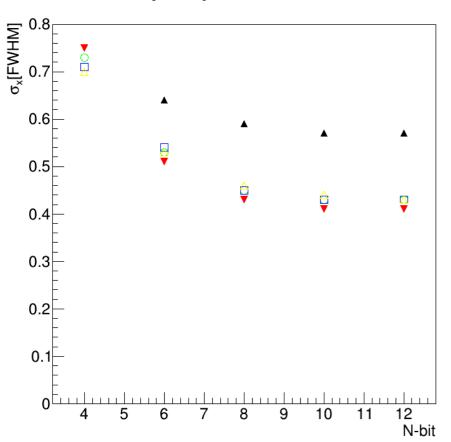
Pos Reso[Stdv] @ N-bit and different Rsheet



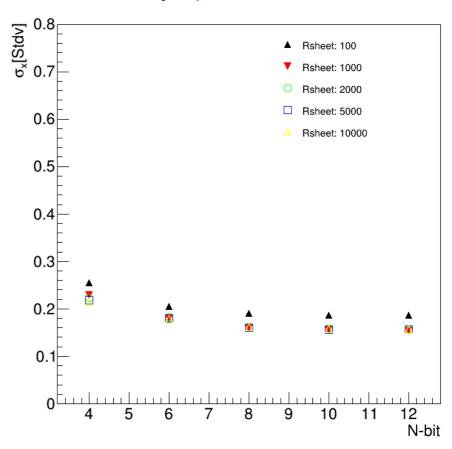
Simulation ADC

Smear with Lan(1, 0.3) Noise: 4mV

Pos Reso[FWHM] @ N-bit and different Rsheet



Pos Reso[Stdv] @ N-bit and different Rsheet



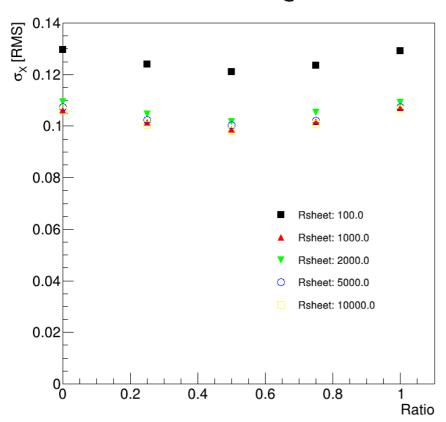
No significant difference between 1mV and 4mV noise level @ 4-bit case. Since the LSB for 4-bit case is 62.5mV is much larger than change of noise.

Conclusion

- The smaller noise and higher ADC-bit give the better resolution
 - 8 & 10 bit has 10% difference between noise @ 1mV and 4mV for [RMS]
 - 8 & 10 bit has 25% difference between noise @ 1mV and 4mV for [FWHM]
- The resolution[FWHM] difference between 10 and 8-bit is ~ 5% pixel width.
- The small Rsheet value(100) have too much sharing to reconstruct well.

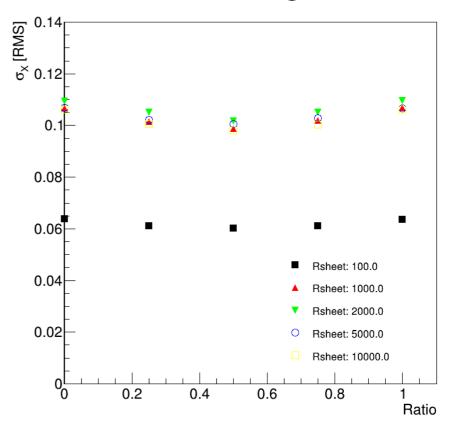
Backup

reconstruct resolution @4mV noise



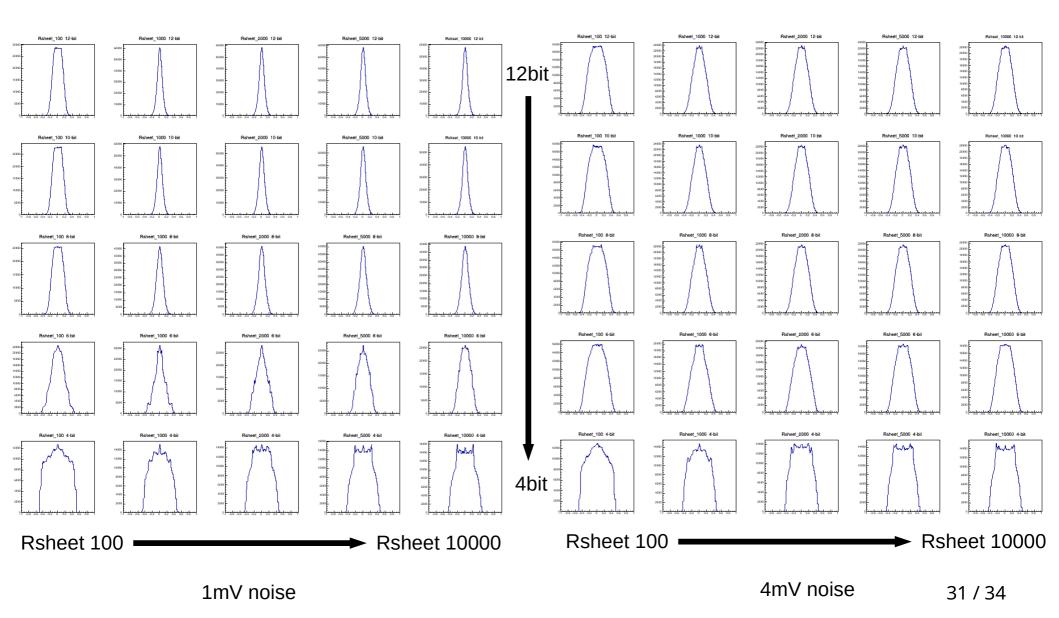
Scale amp of all pixels in Rsheet100 with 1.6

reconstruct resolution @4mV noise



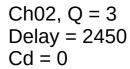
Scale amp of all pixels in Rsheet100 with 3.2

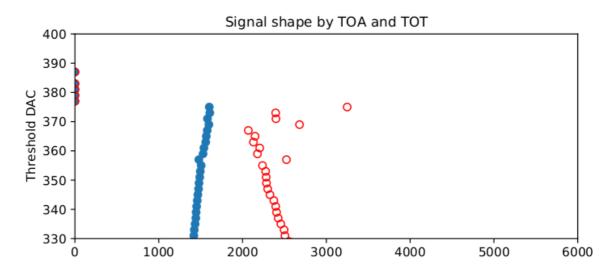
Backup



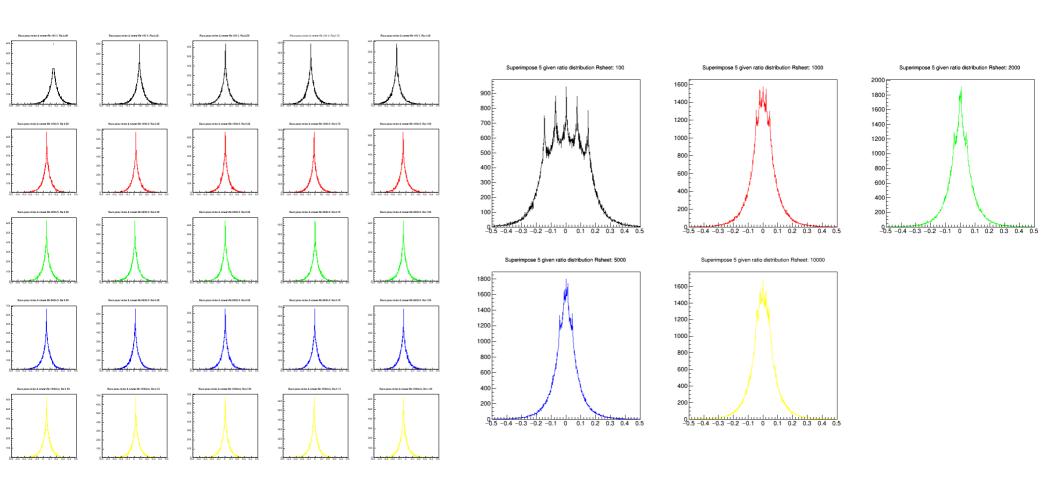
Backup - Testboard

TOA LSB: 30ps TOT LSB: 160ps





Backup - simulation p22 & 26



33 / 34

Jupe IIII pose

5 given ratio [0, 0.25, 0.5, 0.75, 1]

Backup - Simulation specific small ratio

compare with p22 ratio[0, 0.25, 0.5, 0.75, 1]

